

Operation of the CMS Pixel Detector

A. Starodumov, on behalf of the CMS Collaboration

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Outline

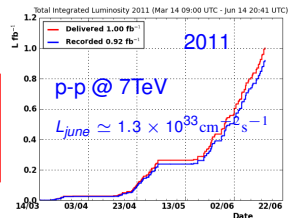
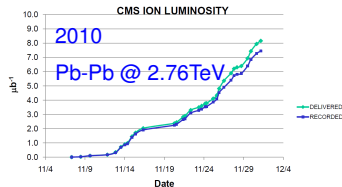
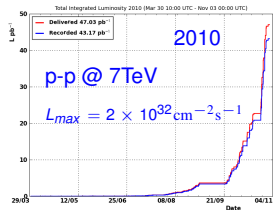
- ▶ The CMS Pixel Detector
- ▶ Operation of the Pixel Detector
- ▶ On-line and off-line calibrations
- ▶ Performance of the Pixel Detector
- ▶ Conclusions

CMS Pixel Detector, Vertex10

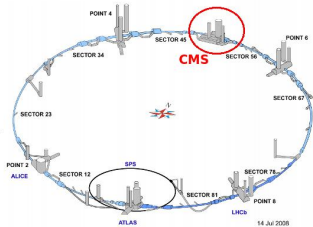
- (Re)Startup Scenario 2010 – 2011
 - $\sqrt{s}=7$ TeV
 - Long Physics Run $L_{\text{peak}}=10^{32}\text{cm}^{-2}\text{s}^{-1}$
 - Integrated $L = 1000 \text{ pb}^{-1}$ goal
- Fewer intense bunches 1E11 p/bunch
Pile up from multiple pp interactions
 $\langle N_{\text{int}} \rangle \sim 2-3$

7 June 2010

CMS Pixels - Karl.Ecklund@rice.edu

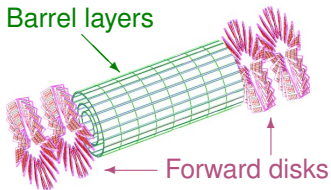


CMS at LHC



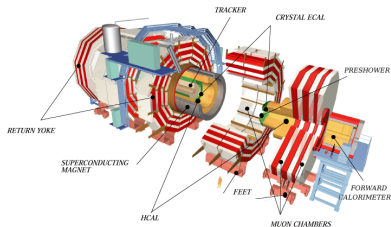
CMS:

- Length 22 m , diameter 15 m, weight 12.5 kton
- Magnetic field 3.8 Tesla



LHC:

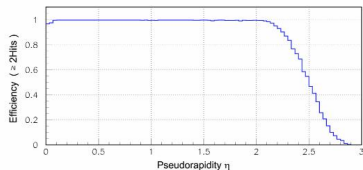
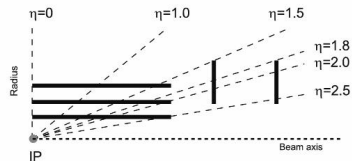
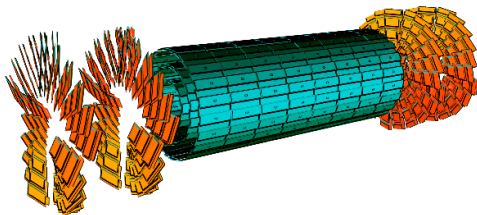
- 27 km ring, 1232 superconducting (1.9 K) dipoles
- $p - p$ collider, 7 TeV each beam
- nominal luminosity $10^{34} \text{ cm}^{-2}\text{s}^{-1}$, rate 40 MHz



Pixel Detector:

- Barrel layers: $l = 53 \text{ cm}$, $R = 4.2, 7.3, 11 \text{ cm}$
- Forward disks: $z = 34.5, 46.5 \text{ cm}$, $R = 6 \div 15 \text{ cm}$
- Area $\sim 1.1 \text{ m}^2$, 66M channels

CMS Pixel Detector I



CMS Pixel Detector built of:

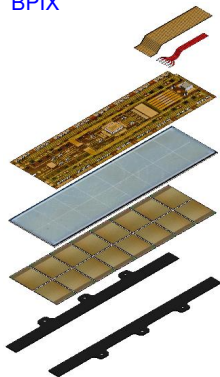
- BPix: 768 modules, 11520 ROCs, 48 Mpixels
- FPix: 192 panels, 4320 ROCs, 18Mpixels

Rapidity coverage:

- with 3 pixel hits up to $|\eta|=2.1$
- with 2 pixel hits within $2.1 < |\eta| < 2.5$

CMS Pixel Detector II

BPIX



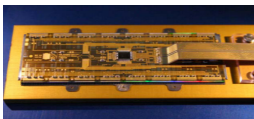
Cables:
signal&power

HDI print
with TBM

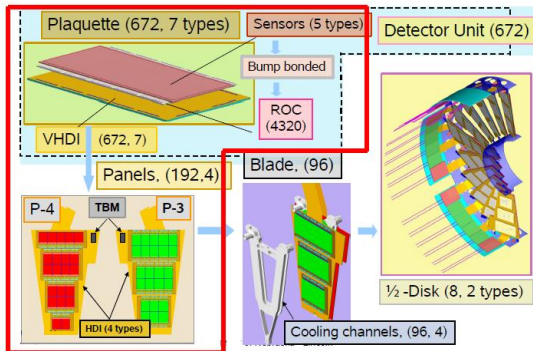
Si sensor

16 ROCs

Base strips:
 Si_3N_4



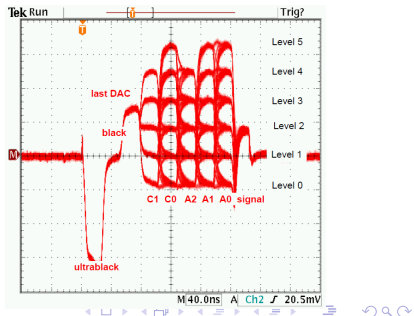
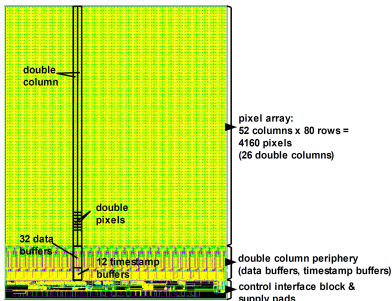
FPIX



- BPIX has 2 module designs: 16ROCs and 8 ROCs
- FPIX has 7 plaquette designs: 2-10 ROCs

Readout Chip

- ▶ ROC designed by PSI, manufactured by IBM
 - ▶ 0.25 μm process, ~ 1.3 million transistors
- ▶ ROC size: $8 \times 8 \text{mm}^2$
 - ▶ 4160 pixels of $100 \times 150 \mu\text{m}^2$ in $r\phi \times z$ (CMS coordinates)
- ▶ 26 adjustable DACs per ROC, 4 trim bits per pixel
- ▶ Double column drain architecture
- ▶ 40 MHz analog readout: analog PH and pixel address



Infrastructure

► Cooling

- ▶ coolant $T=+7.4^{\circ}\text{C}$. Cooling was stable in 2010/11, no problems observed
- ▶ in 2012 we may run at -10°C continuously, successful tests at this temperature done in January
- ▶ humidity problem observed later in February (to be solved during winter stop, details see later)

► Power

- ▶ stable running in 2010/11, no major problems observed
- ▶ one remote sensing wire lost that affected 8 BPix modules

► Electronics

- ▶ hardware was very stable in 2010/11
- ▶ firmware have been modified several time to deal with different problems:
1) high multiplicity events from beam-gas background, 2) internal noise of mezzanine card (corrupted readout), 3) heavy ion events handling

Operation in HI collisions

▶ Pb-Pb collisions in CMS

- ▶ $\sqrt{s} = 2.76$ TeV
- ▶ luminosity $\simeq 3 \times 10^{25} \text{cm}^{-2} \text{s}^{-1}$ for 128×128 bunches
- ▶ minimum bias collision rate 150Hz

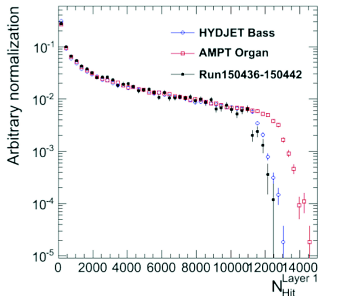
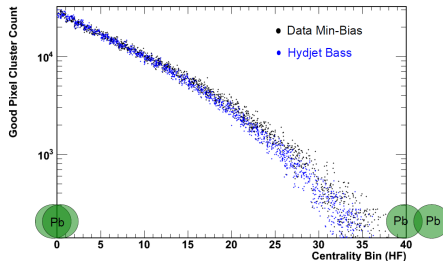
▶ Major differences between p-p and HI

- ▶ much higher multiplicity (but uniform!)
- ▶ much lower collision/trigger rate

▶ To cope with larger event size FEDs buffer size increased

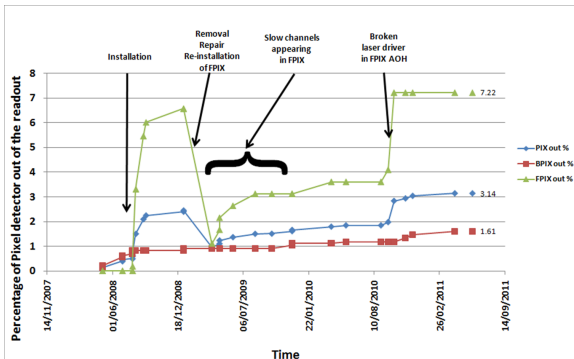
▶ NO problems observed with pixel detector operation in HI collisions

▶ Pixel performance appeared identical to p-p collisions



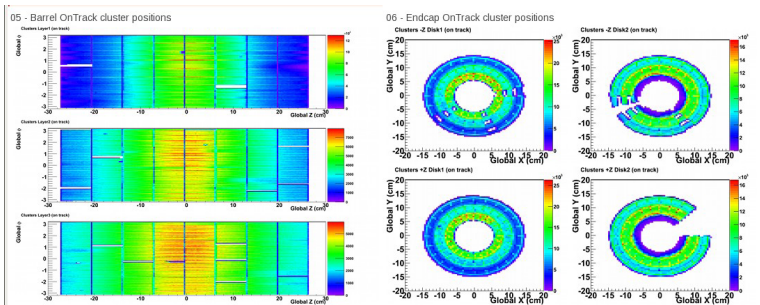
Pixel detector status I

- ▶ The whole Pixel detector: **96.9%** functional ROCs
 - ▶ FPix **92.8%**: 4320-312=4008 functional ROCs
 - ▶ BPix **98.4%**: 11520-186=11334 functional ROCs
- ▶ Total 'dead' random pixels : **$<2 \times 10^{-4}$** in functional ROCs
 - ▶ about 6K ($\sim 10^{-4}$) inefficient pixel found with internal calibration
 - ▶ about 700 ($\sim 10^{-5}$) 'noisy' pixel (masked) found in cosmic ray data



Pixel detector status II

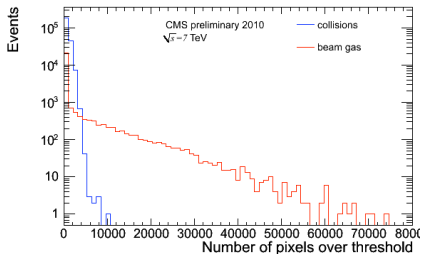
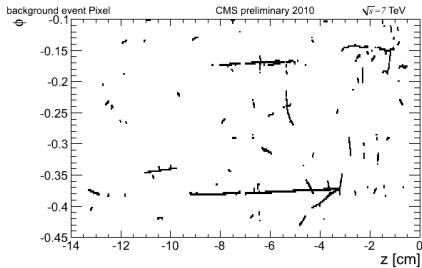
- ▶ Major problems in BPix:
 - ▶ single ROC problems: some recoverable
 - ▶ broken wires: not recoverable
 - ▶ token lost: not recoverable
- ▶ Major problems in FPix:
 - ▶ bad address levels due to slow signal rise time: recoverable in FED FW
 - ▶ no communication with optical transmitter: recoverable if CMS open



Beam-gas background I

► What is beam-background events:

- showers of particles that graze the detector along the beam axis (z)
- occur coincident with bunch crossings
- consistent with beam-gas interactions in the beam pipe
- lead to a huge occupancy in BPix (but concentrated in 1 out of 36 FED channels)
- impose challenges to maintaining event synchronization, especially at high trigger rates



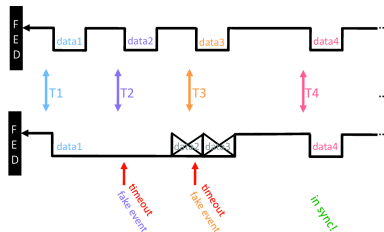
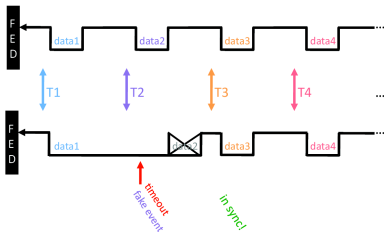
Beam-gas background II

► Where is a problem:

- beam-gas event is large and can block FED(s) for long time
- next event comes at NOT expected time (later)
- FED(s) stays out of synchronization (timeout sent to CMS DAQ)

► Solution:

- 1 drop the event(s) that not arrive when expected (event 'data2')
- 2 if N (tunable) consecutive timeouts, stop CMS trigger, so FED can resynchronize itself

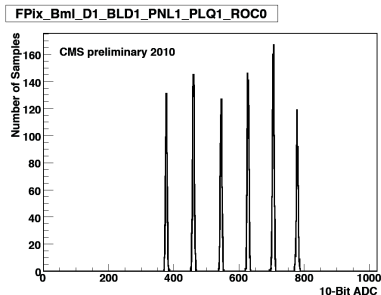


Operational temperature

- ▶ At certain moment we want T be lower, e.g. -10°C
 - ▶ detector need to be re-calibrated (DAC settings)
 - ▶ test has been done in January: not completed due to lack of time
 - ▶ later, in February, observed the RH problem (interlock due to high RH)
- ▶ 'Humidity problem'
 - ▶ it was not observed before winter 2010/11 stop
 - ▶ RH rises when CMS magnet is switched on (above 2-2.5T)
 - ▶ one side of detectors affected more than other
- ▶ Possible explanation and actions
 - ▶ hypothesis: it's known that some parts of CMS move on magnetic field turn on/off, this may create an opening in pixel volume sealing
 - ▶ keep track of RH problem, recover during winter 2011/12 stop

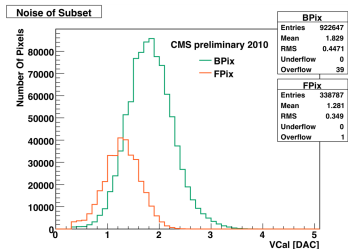
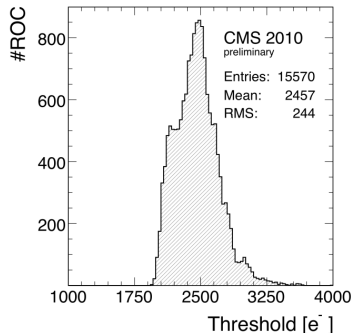
On-line calibrations

- ▶ Proper readout defined by several groups of settings:
 - ▶ at module level: ROC and TBM parameters
 - ▶ optical readout chain: AOH and DOH parameters
 - ▶ FED parameters
- ▶ Majority of settings stays unchanged until:
 - ▶ detector temperature will be changed
 - ▶ significant irradiation will be accumulated
- ▶ Some parameters in FEDs regularly re-calibrated:
 - ▶ adjust offset in optical receivers to keep signal within ADC range: small corrections made automatically, large - by recalibration
 - ▶ ADC levels needed to decode pixel addresses: mostly as a check
 - ▶ clock phase: phase of ADC, performed only as a check



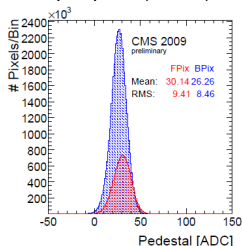
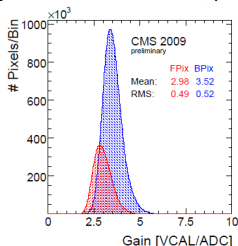
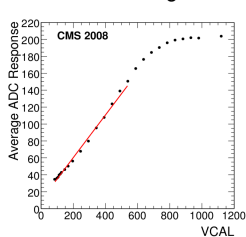
On-line calibration: threshold

- ▶ Motivation:
 - ▶ lower threshold - lower pixel charge reconstructable then longer cluster
 - ▶ longer cluster size - better spacial hit resolution
- ▶ Threshold minimization
 - ▶ minimization done with help of internal calibrate signal (VCal)
 - ▶ method limitation: x-talk in ROC
- ▶ Mean threshold = 2457 electrons
- ▶ Mean noise less than 150 electrons
 - ▶ Conversion (from X-ray calibration):
 $Q[e^-] = 65.5 \times VCal[DAC] - 414$



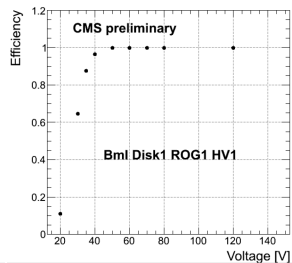
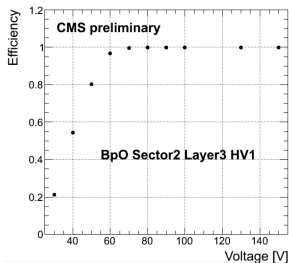
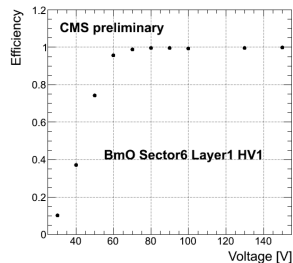
Off-line calibration: ADC to Charge

- ▶ Relate PH (ADC) to deposited charge
 - ▶ ADC-to-Vcal done once a year (more often for control)
 - ▶ VCal-to-Charge calibration done in the lab with X-ray sources
- ▶ offline ADC-to-Vcal calibration:
 - ▶ fit **single pixel** response with linear function
 - ▶ result of the fit: gain and pedestal
- ▶ Granularity of constants used in CMS
 - ▶ HLT: averaged over ROC column (payload 800kB)
 - ▶ RECO: gain averaged over ROC column, pedestal per pixel (33MB)



High voltage scan

- ▶ HV scan performed on April 2010 and March 2011
- ▶ Few modules in BPix and FPix selected to be monitored
- ▶ No change observed in the depletion voltage (60-70V)



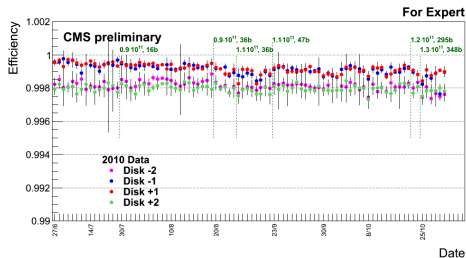
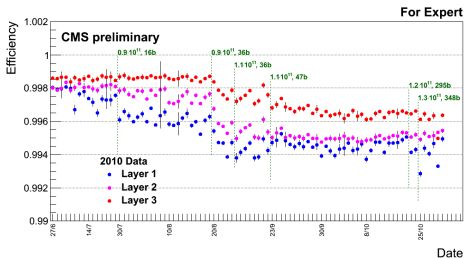
Pixel efficiency

▶ Barrel Pixel detector in 2010:

- ▶ the initial average protons per bunch and the number of bunches (colliding in CMS) are shown in green
- ▶ expected dynamic efficiency loss due to increased bunch charge and number of bunches (occupancy increase)
- ▶ overall decrease in efficiency in all layers of 0.2%-0.4%

▶ Forward Pixel detector in 2010

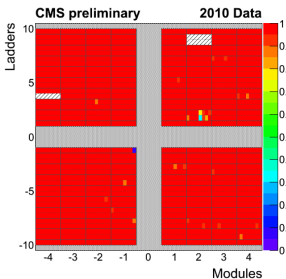
- ▶ Efficiency on the Fpix stays within the systematics uncertainty of 0.002



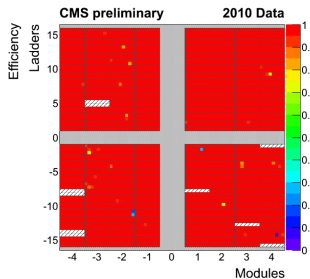
BPix efficiency

- ▶ ROC efficiency represented per layer
 - ▶ hatched area represents inactive modules
 - ▶ ladder index changes along ϕ , module index changes along z
- ▶ Systematic uncertainty on ROC efficiency is 2×10^{-3}
- ▶ Statistical uncertainty on ROC efficiency is $10^{-4} \div 10^{-3}$
- ▶ Inefficiency concentrated in single ROCs

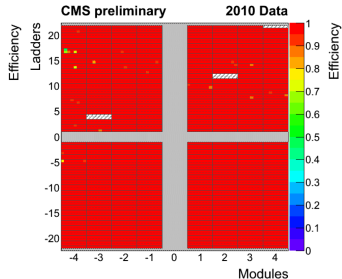
BPix layer 1



BPix layer 2

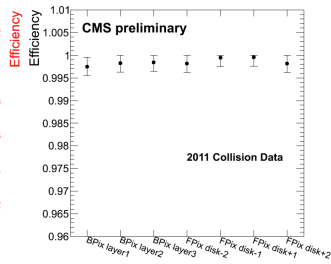
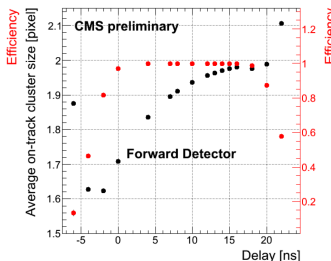
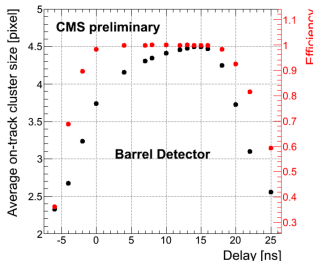


BPix layer 3



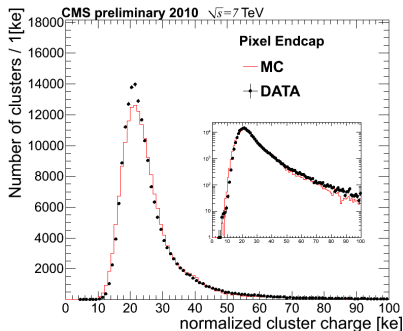
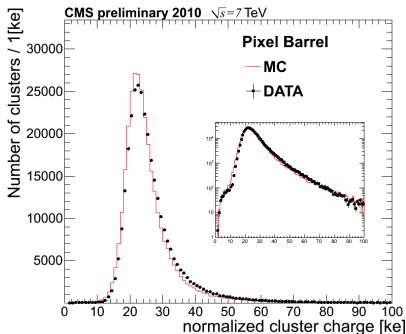
Time delay scan

- ▶ Timing affects cluster size (charge collection efficiency) due to time walk
 - ▶ low pulses exceed threshold later than large pulses
 - ▶ adjust timing to latest possible with respect to LHC clock
- ▶ Methods used
 - ▶ determine maximum cluster size plateau with step 6ns
 - ▶ make fine scan with high statistics near the end of plateau (2ns)



Cluster charge distribution

- ▶ LHC collision data @ 7 TeV
 - ▶ corrected to incident angle hit cluster charge for tracks with $p_{\perp} > 2$ GeV
- ▶ MC simulation provides accurate description of data
 - ▶ peak position correct to 2-4%, width 10-15%



Pixel hit resolution

▶ Intrinsic position resolution with overlap method

- ▶ pairs of consecutive hits of track in the same layer
- ▶ difference of measured hit positions
- ▶ difference of extrapolated hit positions
- ▶ difference of two differences
- ▶ reduced sensitivity to alignment and extrapolation errors

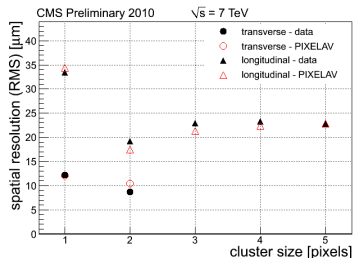
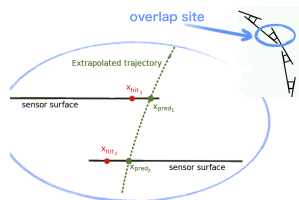
▶ 1316 overlap regions analyzed (8.3M hit pairs)

▶ Good agreement data-MC: $\pm 1 \mu\text{m}$

▶ Intrinsic hit position resolution:

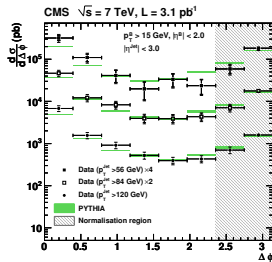
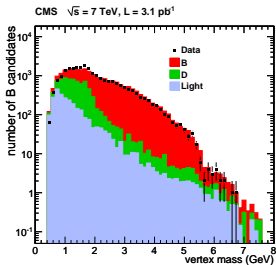
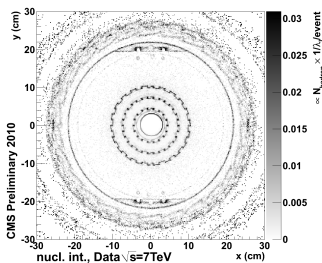
$$\sigma_{trans} = 11.2 \pm 0.1 \mu\text{m}$$

$$\sigma_{long} = 26.8 \pm 0.1 \mu\text{m}$$



Pixel data applications

- ▶ Pixel data has many applications apart of physics:
 - ▶ PV allows to monitor beam spot position and width
 - ▶ photon conversion or NI points are used for material distribution studies
 - ▶ follow [Giacomo Sguazzoni talk on CMS Tracker performance](#)
- ▶ Physics Example: $b\bar{b}$ angular correlations based on SV:
 - ▶ final goal to measure different $b\bar{b}$ production mechanisms: FC, GS and FE, and test pQCD LO and NLO x-sections and their evolution with energy
 - ▶ algorithm allows to distinguish 2 b -particles even if 2 b -jets are merged and hence sensitive to small $\Delta\phi_{b\bar{b}}$



Conclusions

- ▶ Smooth operation of pixel detector in 2010/11, both in p-p and HL
- ▶ Pixel detector provides high quality data used in various physics analyses
- ▶ Performance of the detector under control
- ▶ Changes in 2010
 - ▶ 'unattended' operation of the detector: only central crew and expert on call
 - ▶ beam-gas background problem understood and downtime caused reduced
 - ▶ functional fraction 96.7% (1.5% lost in 2010), some to be recovered
 - ▶ downtime caused by pixel detector improved (already very small), work ongoing to recover remaining losses
- ▶ Preparation to cooler operation has started
 - ▶ tests of the detector operation and calibration at -10°C
 - ▶ RH problem under investigation, working on possible solutions

Back up slides

Organization

- ▶ Pixel field manager: one person
- ▶ On call experts (former shift leaders)
 - ▶ since summer 2010 we do not have permanent pixel shifter at P5 (3 persons a day)
 - ▶ only one person (on call expert is responsible for the operation)
 - ▶ now we have about 20 people to perform this task
- ▶ Pixel DAQ
 - ▶ pixel DAQ SW, run control (interface to the central DAQ): 2-3 persons
 - ▶ pixel configuration DB: 2-3 persons
- ▶ pixel DCS common with strip group: 3 persons from pixel side and 2-3 from strips
- ▶ pixel DQM: 2 persons

Detector status: known problems

Detector component	# ROCs	Problem
FPix_BmO_D1_BLD9_PNL2	24	low signal amp. (bad TBM)
FPix_Bml_D1_BLD11_PNL2	24	one ROC without analog output, whole panel lost
FPix_BmO_D2_BLD8_PNL2	24	bad Address Levels (slow rise-time)
FPix_BmO_D2_BLD8_PNL1	21	bad Address Levels (slow rise-time)
FPix_BmO_D2_BLD7_PNL1	21	bad Address Levels (slow rise-time)
FPix_BmO_D2_BLD9_PNL1	21	bad Address Levels (slow rise-time)
FPix_Bml_D2_BLD10_PNL1	21	bad Address Levels (slow rise-time)
FPix_Bml_D1_BLD6_PNL1	21	no signal
FPix_Bpl_D2_BLD4_PNL1	21	no I2C to AOH, need to open CMS
FPix_Bpl_D2_BLD4_PNL2	24	no I2C to AOH, need to open CMS
FPix_Bpl_D2_BLD5_PNL1	21	no I2C to AOH, need to open CMS
FPix_Bpl_D2_BLD5_PNL2	24	no I2C to AOH, need to open CMS
FPix_Bpl_D2_BLD6_PNL1	21	no I2C to AOH, need to open CMS
FPix_Bpl_D2_BLD6_PNL2	24	no I2C to AOH, need to open CMS
BPix_Bpl_SEC5_LYR3_LDR12F_MOD2	16	no HV
BPix_Bpl_SEC8_LYR3_LDR22H_MOD4	8	no HV
BPix_BpO_SEC1_LYR2_LDR1H_MOD4	8	no HV
BPix_BpO_SEC8_LYR2_LDR16H_MOD4	8	no HV
BPix_BpO_SEC7_LYR2_LDR13F_MOD3 TBM-B	8	token lost
BPix_Bml_SEC2_LYR3_LDR4F_MOD3	16	token lost
BPix_BpO_SEC4_LYR2_LDR8F_MOD1 TBM-A	8	bad ROC
BPix_Bml_SEC3_LYR2_LDR5F_MOD3 TBM-A	8	bad ROC header
BPix_Bml_SEC3_LYR2_LDR5F_MOD3 TBM-B	8	ROC cannot be programmed
BPix_BmO_SEC7_LYR2_LDR14F_MOD4	16	dead module
BPix_Bpl_SEC8_LYR1_LDR9F_MOD2	16	no trigger
BPix_BmO_SEC4_LYR2_LDR8F_MOD4 TBM-A	8	bad ROC
BPix_Bml_SEC3_LYR1_LDR4F_MOD4 TBM-B	8	no signal (wire bond?)
BPix_BpO_SEC7_LYR3_LDR19F_MOD2	16	token lost
BPix_Bpl_SEC1_LYR3_LDR3F_MOD2	16	can't be programmed
BPix_Bml_SEC5_LYR3_LDR13F_MOD2	16	remote sensing wire

Infrastructure status II

▶ Detector Control System (DCS)

- ▶ monitor power (LV and HV), T and RH: stable functioning
- ▶ several things still have been modified (like staged BPix turn on)
- ▶ calibration of humidity and dew-points have been made at the beginning of 2011

▶ Data Quality Monitor (DQM)

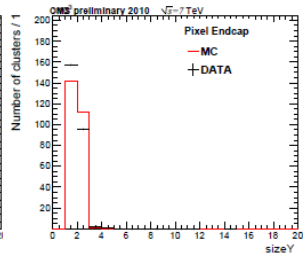
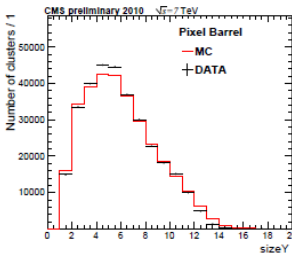
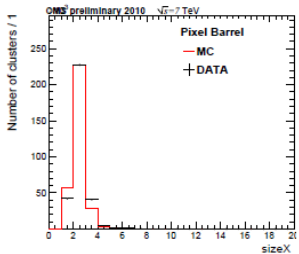
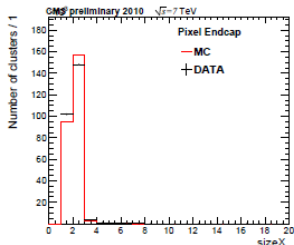
- ▶ with data taking experience permanently improving the monitoring
- ▶ due to unattended pixel operation since summer 2010, central DQM shifters have been provided with clear plots and instructions

▶ Pixel on-line SW (POS)

- ▶ written very well from the beginning
- ▶ all needed calibrations of the detector work very reliably
- ▶ concerns about man power to support the SW on a long term bases

Cluster size

- ▶ Cluster size distributions: note different geometry of forward and barrel pixel detectors
 - ▶ BPix:
 - local X corresponds to global $r\phi$ (short clusters)
 - local Y corresponds to global z (long clusters)
 - ▶ FPix: all tracks almost perpendicular to sensor
 - in both directions clusters are short
- ▶ MC simulation describes data quite well

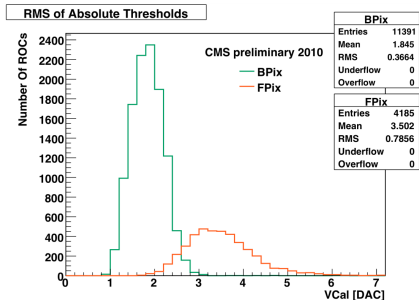
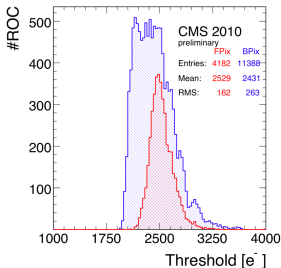


Thresholds

► Procedure :

- The mean absolute threshold on each ROC is computed from a subset of pixels on the ROC (2%)
- The absolute threshold of each pixel is obtained from an SCurve calibration covering two bunch crossings
- An SCurve is the hit efficiency as a function of injected charge (VCal).
- The threshold is taken as the VCal corresponding to 50% efficiency

► Conversion: $\#electrons = 65.5 \times VCal - 414$ (X-ray calib.)



DACs optimization

- ▶ Few operational parameters are T dependent
 - ▶ some DACs tuned dynamically, so no need for a special procedure
 - ▶ others should be re-adjusted
- ▶ BPix
 - ▶ 2 sets of DACs for +17°C and -10°C taken at PSI
 - ▶ T dependence approximately linear
 - ▶ new DACs obtained by linear interpolation from 2 sets
- ▶ FPix
 - ▶ DACs tuned in P5 using special calibration procedures
- ▶ Thresholds are minimized in BPix/FPix: 2740/2480 e⁻